

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26 D-32758 Detmold Germany

www.weidmueller.com

Product image





















The inverted BCL-SMT socket block for the PCB offers three significant advantages:

- The BCL-SMT offers touch-safe security on the PCB which makes it ideal for live, current-carrying outputs.
- The BCL-SMT widens the range of applications with board-to-board connections between component assemblies.
- The BCL-SMT is reflow-compatible and can be seamlessly integrated into the automatic assembly and soldering process.

Two outlet directions give you a choice of position and thus more design flexibility.

- 180° standing
- 90° recumbent

Two housing variants are available for the BCL-SMT:

- Without flange
- With inverted solder flange ("LFI", with nut)
- · Fastened to PCB without additional screw
 - · Fastened with screw to the SCZ FI

Weidmüller's 3.81-mm-pitch (0.15 inch) plug-in connectors are compatible with the layouts of customary connectors and offer space for labelling and coding.

General ordering data

Version	PCB plug-in connector, female header, closed side
	THT/THR solder connection, 3.81 mm, Number
	of poles: 10, 180°, Solder pin length (I): 1.5 mm,
	tinned, black, Box
Order No.	<u>1976610000</u>
Туре	BCL-SMT 3.81/10/180 1.5SN BK BX
GTIN (EAN)	4032248679065
Qty.	50 pc(s).
Product data	IEC: 320 V / 17.5 A
	UL: 300 V / 10 A
Packaging	Box



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Technical data

Dim	ensions	and	weights
	GIISIUIIS	anu	WEIGHT

Net weight	4.26 a	

System specifications

Product family	OMNIMATE Signal - series	Type of connection	
·	BC/SC 3.81		Board connection
Mounting onto the PCB	THT/THR solder	Pitch in mm (P)	
	connection		3.81 mm
Pitch in inches (P)	0.15 inch	Outgoing elbow	180°
Number of poles	10	Number of solder pins per pole	2
Solder pin length (I)	1.5 mm	Solder pin length tolerance	0 / -0,02 mm
Solder pin dimensions	d = 0.8 mm	Solder pin dimensions = d tolerance	+0,05 / -0,05 mm
Solder eyelet hole diameter (D)	1.2 mm	Solder eyelet hole diameter tolerance ([0)+ 0,1 mm
Outside diameter of solder pad	1.9 mm	Template aperture diameter	1.6 mm
L1 in mm	34.29 mm	L1 in inches	1.35 inch
Number of rows	1	Pin series quantity	1
Touch-safe protection acc. to DIN VDE		Touch-safe protection acc. to DIN VDE	
57 106	Safe from finger touch	0470	IP 20
Volume resistance	≤5 mΩ	Can be coded	Yes
Plugging force/pole, max.	9.5 N	Pulling force/pole, max.	6 N

Material data

Insulating material	LCP GF	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	Illa
Comparative Tracking Index (CTI)	≥ 175	Moisture Level (MSL)	1
UL 94 flammability rating	V-0	Contact material	Copper alloy
Contact surface		Layer structure of solder connection	13 μm Ni / 24 μm Sn
	tinned		matt
Layer structure of plug contact	13 μm Ni / 24 μm Sn	Storage temperature, min.	
	matt		-40 °C
Storage temperature, max.	70 °C	Operating temperature, min.	-50 °C
Operating temperature, max.	120 °C	Temperature range, installation, min.	-25 °C
Temperature range, installation, max.	120 °C		

Rated data acc. to IEC

tested acc. to standard	IEC 60664-1, IEC 61984	Rated current, min. number of poles $(Tu=20^{\circ}C)$	17.5 A
Rated current, max. number of poles (Tu=20°C)	15.4 A	Rated current, min. number of poles (Tu=40°C)	17.5 A
Rated current, max. number of poles (Tu=40°C)	13.8 A	Rated voltage for surge voltage class / pollution degree II/2	320 V
Rated voltage for surge voltage class / pollution degree III/2	160 V	Rated voltage for surge voltage class / pollution degree III/3	160 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	2.5 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	2.5 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	2.5 kV	Short-time withstand current resistance	3 x 1s with 76 A

Rated data acc. to CSA

Rated voltage (Use group B / CSA)	300 V	Rated voltage (Use group C / CSA)	50 V
Rated current (Use group B / CSA)	11 A	Rated current (Use group C / CSA)	11 A



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Technical data

Rated data acc. to UL 1059

Institute (cURus)		Certificate No. (cURus)	
			E60693
Rated voltage (Use group B / UL 1059)	300 V	Rated voltage (Use group D / UL 1059)	300 V
Rated current (Use group B / UL 1059)	10 A	Rated current (Use group D / UL 1059)	10 A
Reference to approval values	Specifications are maximum values, details - see approval certificate.		

Packing

Packaging	Box	VPE length	25 mm
VPE width	120 mm	VPE height	205 mm

Classifications

ETIM 6.0	EC002637	ETIM 7.0	EC002637
ECLASS 9.0	27-44-04-02	ECLASS 9.1	27-44-04-02
ECLASS 10.0	27-44-04-02	ECLASS 11.0	27-46-02-01

Important note	
IPC conformity	Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.
Notes	Rated current related to rated cross-section & min. No. of poles.
	• P on drawing = pitch
	 Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards.
	 Long term storage of the product with average temperature of 50 °C and average humidity 70%, 36 months

	 Long term storage of the product with average temperature of 50 °C and average humidity 70%, 36 months
Approvals	
Approvals	c SAL us III
ROHS	Conform
UL File Number Search	E60693
Downloads	
Approval/Certificate/Document of Conformity	Declaration of the Manufacturer
Engineering Data	STEP
Engineering Data	EPLAN, WSCAD



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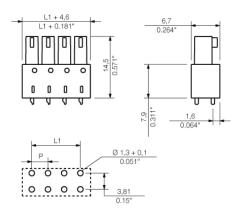
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Drawings

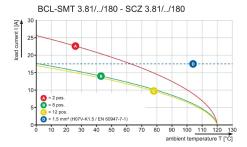
Product image



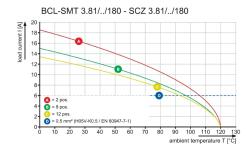
Dimensional drawing

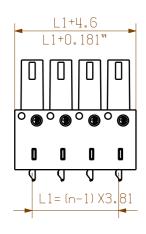


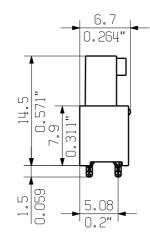
Graph

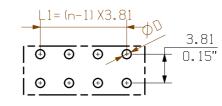


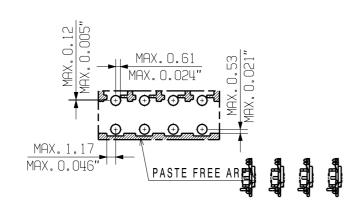
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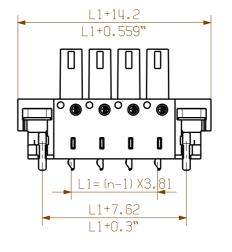


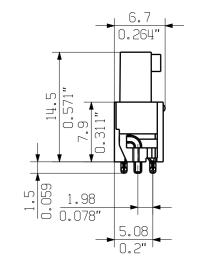


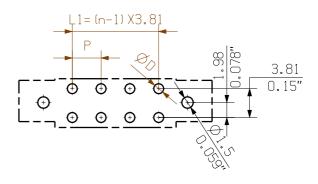


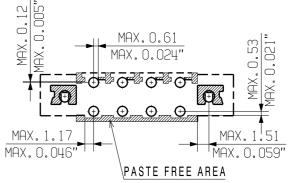












NOTE: n=NO OF POLES

P=PITCH

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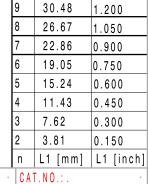
For the mounting of PCBs, it should be noted that the rated data given in the catalogue relates only to the connection elements. The neccessary creepage and clearance paths must be observed in connection with the respective applicant in accordance to VDE 0110. The current-carrying capacity and pitch tolerance is to be determined according to DIN IEC 326 part 3 very fine

Weidmüller connectors are tested to the DIN VDE 0627 standard, and are valid for its field of application. Provided that the connectors are used to the intended purpose, all requirements with respect to the occuring of electrical, mechanical, thermic and corrosive stress will be satisfied.

CUSTOMER DRAWING

SUPERSEDED BY:

APPROVED



41.91

38.10

34.29

1.650

1.500

1.350



PRODUCT FILE: BCL-SMT 3.81

XU_S



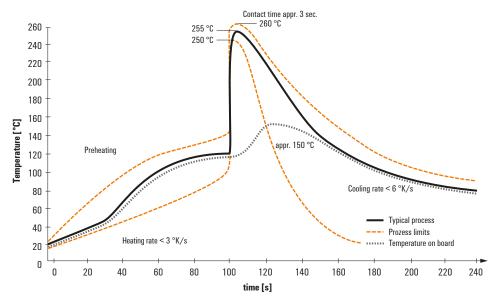
Recommended wave solderding profiles

Weidmüller Interface GmbH & Co. KG

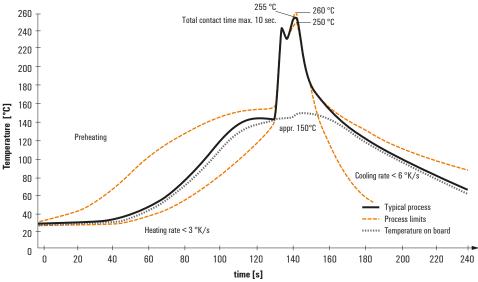
Klingenbergstraße 16 D-32758 Detmold Germany

Fon: +49 5231 14-0 Fax: +49 5231 14-292083 www.weidmueller.com

Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

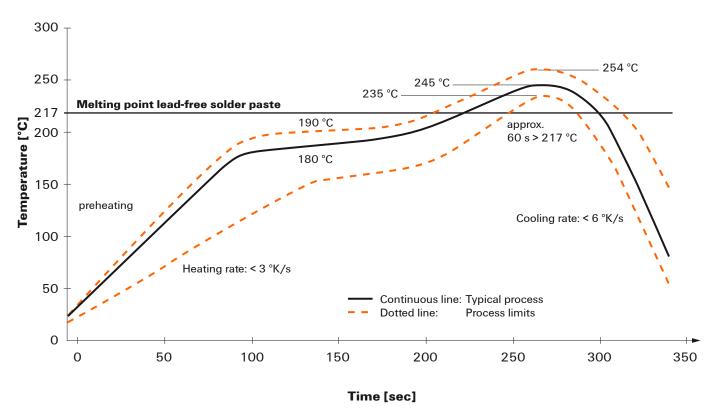


Recommended reflow soldering profile

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Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- · Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- · Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3$ K/s. In parallel the solder paste is ,activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at \geq -6K/s solder is cured. Board and components cool down while avoiding cold cracks.